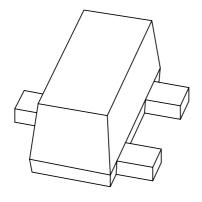
# DISCRETE SEMICONDUCTORS

# DATA SHEET



1PS89SB14; 1PS89SB15; 1PS89SB16 Schottky barrier double diodes

Product specification Supersedes data of 1998 Nov 10 2003 Apr 28





# Schottky barrier double diodes

1PS89SB14; 1PS89SB15; 1PS89SB16

### **FEATURES**

- Power dissipation comparable to SOT23
- · Low forward voltage
- · Guard ring protected
- Ultra small SMD package.

# **APPLICATIONS**

- · Ultra high speed switching
- · Voltage clamping
- · Protection circuits
- · Blocking diodes.

### **DESCRIPTION**

Planar Schottky barrier double diodes encapsulated in an ultra small plastic SMD SC-89 (SOT490) package.

## **MARKING**

TYPE NUMBER	MARKING CODE
1PS89SB14	44
1PS89SB15	43
1PS89SB16	45

#### PINNING

PIN	1PS89SBxx				
PIN	14	15	16		
1	a <sub>1</sub>	a <sub>1</sub>	k <sub>1</sub>		
2	k <sub>2</sub>	a <sub>2</sub>	k <sub>2</sub>		
3	k <sub>1</sub> , a <sub>2</sub>	k <sub>1</sub> , k <sub>2</sub>	a <sub>1</sub> , a <sub>2</sub>		

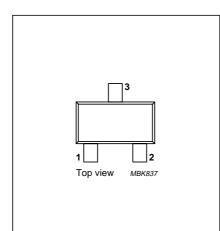


Fig.1 Simplified outline (SC-89; SOT490) and pin configuration.

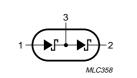


Fig.2 1PS89SB14 diode configuration (symbol).

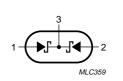


Fig.3 1PS89SB15 diode configuration (symbol).

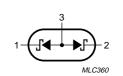


Fig.4 1PS89SB16 diode configuration (symbol).

# Schottky barrier double diodes

1PS89SB14; 1PS89SB15; 1PS89SB16

### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
Per diode	Per diode unless otherwise specified						
V <sub>R</sub>	continuous reverse voltage		_	30	V		
I <sub>F</sub>	continuous forward current		_	200	mA		
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ s}; \ \delta \le 0.5$	_	300	mA		
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> < 10 ms	_	600	mA		
P <sub>tot</sub>	total power dissipation (per package)	T <sub>amb</sub> ≤ 25 °C	_	200	mW		
T <sub>stg</sub>	storage temperature		-65	+150	°C		
Tj	junction temperature		_	125	°C		
T <sub>amb</sub>	operating ambient temperature		-65	+125	°C		

### **ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT		
Per diode	Per diode unless otherwise specified					
V <sub>F</sub>	forward voltage	see Fig.5				
		I <sub>F</sub> = 0.1 mA	240	mV		
		I <sub>F</sub> = 1 mA	320	mV		
		I <sub>F</sub> = 10 mA	400	mV		
		I <sub>F</sub> = 30 mA	500	mV		
		I <sub>F</sub> = 100 mA	800	mV		
I <sub>R</sub>	reverse current	V <sub>R</sub> = 25 V; note 1; see Fig.6	2	μΑ		
C <sub>d</sub>	diode capacitance	$f = 1 \text{ MHz}$ ; $V_R = 1 \text{ V}$ ; see Fig.7	10	pF		

### Note

1. Pulse test:  $t_p \le 300 \ \mu s; \ \delta \le 0.02.$ 

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	500	K/W

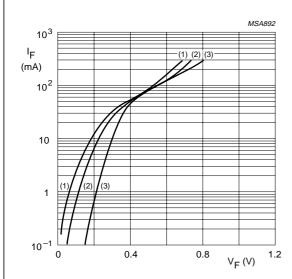
### Note

1. Refer to SC-89 (SOT490) standard mounting conditions.

# Schottky barrier double diodes

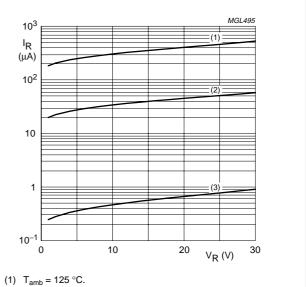
1PS89SB14; 1PS89SB15; 1PS89SB16

### **GRAPHICAL DATA**



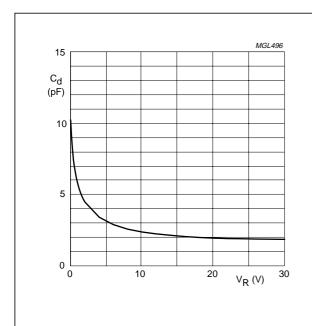
- (1) T<sub>amb</sub> = 125 °C.
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .

Fig.5 Forward current as a function of forward voltage; typical values.



- (2)  $T_{amb} = 85 \,^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .

Fig.6 Reverse current as a function of reverse voltage; typical values.



f = 1 MHz;  $T_{amb} = 25 \, ^{\circ}\text{C}$ .

Diode capacitance as a function of reverse voltage; typical values.

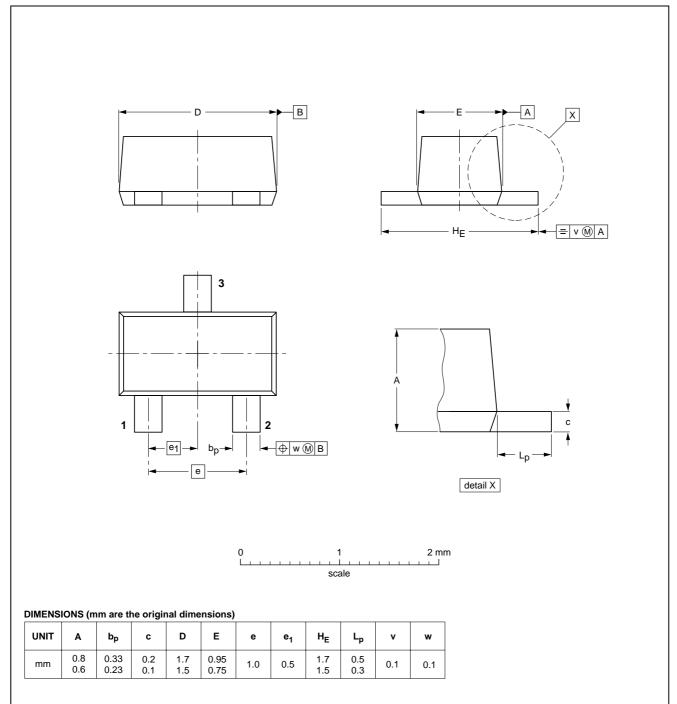
# Schottky barrier double diodes

1PS89SB14; 1PS89SB15; 1PS89SB16

## **PACKAGE OUTLINE**

Plastic surface mounted package; 3 leads

SOT490



OUTLINE		REFERENCES			EUROPEAN	ISSUE DATE	
	VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
	SOT490			SC-89			98-10-23
		•					

# Schottky barrier double diodes

1PS89SB14; 1PS89SB15; 1PS89SB16

#### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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# Schottky barrier double diodes

1PS89SB14; 1PS89SB15; 1PS89SB16

**NOTES** 

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Printed in The Netherlands

613514/02/pp8

Date of release: 2003 Apr 28

Document order number: 9397 750 11056

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